BUK7909-75AIE



N-channel TrenchPLUS standard level FET

Rev. 02 — 17 February 2009

Product data sheet

1. Product profile

1.1 General description

Standard level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. The devices include TrenchPLUS current sensing and diodes for ElectroStatic Discharge (ESD) protection. This product has been designed and qualified to the appropriate AEC standard for use in automotive critical applications.

1.2 Features and benefits

- Electrostatically robust due to integrated protection diodes
- Low conduction losses due to low on-state resistance
- Q101 compliant

- Reduced component count due to integrated current sensor
- Suitable for standard level gate drive sources

1.3 Applications

Electrical Power Assisted Steering (EPAS) Variable Valve Timing for engines

1.4 Quick reference data

Table 1. Quick reference

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{DS}	drain-source voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}$		-	-	75	V
I_D	drain current	$V_{GS} = 10 \text{ V}; T_{mb} = 25 \text{ °C};$ see <u>Figure 2</u> ; see <u>Figure 3</u>	[1]	-	-	120	Α
Static ch	aracteristics						
R _{DSon}	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 50 \text{ A};$ $T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure 7}}{\text{see } \frac{\text{Figure 8}}{\text{Figure 8}}}$		-	8	9	mΩ
I _D /I _{sense}	ratio of drain current to sense current	$T_j > -55 \text{ °C}; T_j < 175 \text{ °C}; V_{GS} > 10 \text{ V}$		450	500	550	

[1] Current is limited by power dissipation chip rating.



2. Pinning information

Table 2. Pinning information

		<u> </u>		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		d
2	ISENSE	sense current	mb	
3	D	drain		
4	KS	Kelvin source		
5	S	source		g \ \ \ \
mb D	mounting base; connected to drain	12345	MBL368 Isense Kelvin source	
			SOT263B (TO-220)	

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BUK7909-75AIE	TO-220	plastic single-ended package; heatsink mounted; 1 mounting hole; 5-lead TO-220	SOT263B

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{DS}	drain-source voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}$		-	75	V
V_{DGS}	drain-gate voltage			-	75	V
V_{GS}	gate-source voltage			-20	20	V
I _D	drain current	T_{mb} = 25 °C; V_{GS} = 10 V; see <u>Figure 2</u> ; see <u>Figure 3</u>	[1]	-	120	Α
			[2]	-	75	Α
		T _{mb} = 100 °C; V _{GS} = 10 V; see <u>Figure 2</u>	[2]	-	75	Α
I_{DM}	peak drain current	T_{mb} = 25 °C; $t_p \le 10 \mu s$; pulsed; see <u>Figure 3</u>		-	480	Α
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 1</u>		-	272	W
	gate-source clamping	continuous		-	10	mA
	current	pulsed; $t_p = 5 \text{ ms}$; $\delta 0.01$		-	50	mA
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
Source-dra	ain diode					
I _S	source current	$T_{mb} = 25 ^{\circ}C$	[1]	-	120	Α
			[2]	-	75	Α
I _{SM}	peak source current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$		-	480	Α
Avalanche	ruggedness					
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	I_D = 75 A; $V_{sup} \le$ 75 V; R_{GS} = 50 Ω ; V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; unclamped		-	739	mJ
Electrosta	tic discharge					
V _{esd}	electrostatic discharge voltage	HBM; C = 100 pF; R = 1.5 kΩ		-	6	kV

^[1] Current is limited by power dissipation chip rating.

^[2] Continuous current is limited by package.

N-channel TrenchPLUS standard level FET

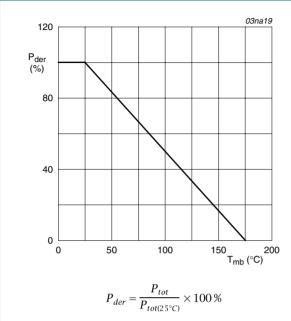


Fig 1. Normalized total power dissipation as a function of mounting base temperature

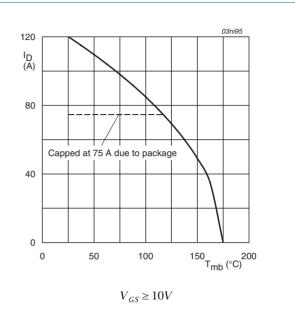
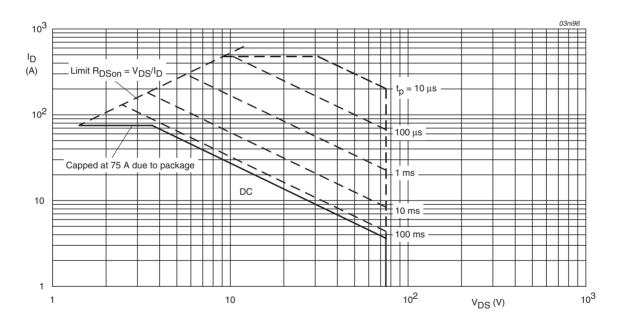


Fig 2. Continuous drain current as a function of mounting base temperature



 $T_{mb} = 25$ °C; I_{DM} is single pulse

Fig 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	vertical in still air	-	60	-	K/W
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see Figure 4	-	-	0.55	K/W

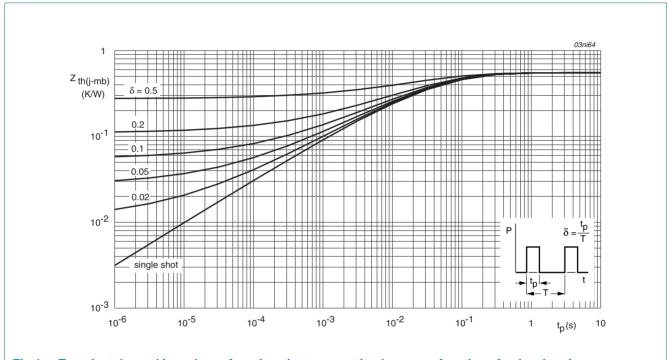


Fig 4. Transient thermal impedance from junction to mounting base as a function of pulse duration

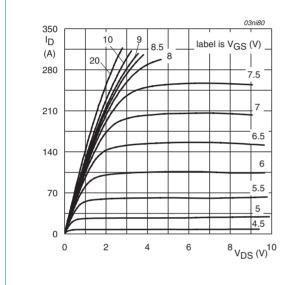
6. Characteristics

Table 6. Characteristics

Table 6.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
$V_{(BR)DSS}$	drain-source	$I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	75	-	-	V
	breakdown voltage	$I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V}; T_j = -55 \text{ °C}$	70	-	-	V
V _{GS(th)} gate-source threshold voltage		$I_D = 1$ mA; $V_{DS} = V_{GS}$; $T_j = 25$ °C; see Figure 9	2	3	4	V
		$I_D = 1$ mA; $V_{DS} = V_{GS}$; $T_j = 175$ °C; see Figure 9	1	-	-	V
		$I_D = 1$ mA; $V_{DS} = V_{GS}$; $T_j = -55$ °C; see Figure 9	-	-	4.4	V
I _{DSS}	drain leakage current	$V_{DS} = 75 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	0.1	10	μΑ
		V _{DS} = 75 V; V _{GS} = 0 V; T _j = 175 °C	-	-	250	μΑ
(gate-source breakdown voltage	$I_G = 1 \text{ mA}; V_{DS} = 0 \text{ V}; T_j > -55 \text{ °C};$ $T_j < 175 \text{ °C}$	20	22	-	V
		$I_G = -1 \text{ mA}; V_{DS} = 0 \text{ V}; T_j > -55 \text{ °C};$ $T_j < 175 \text{ °C}$	20	22	-	V
I _{GSS}	gate leakage current	$V_{DS} = 0 \text{ V}; V_{GS} = 10 \text{ V}; T_j = 25 \text{ °C}$	-	22	1000	nA
		$V_{DS} = 0 \text{ V}; V_{GS} = -10 \text{ V}; T_j = 25 \text{ °C}$	-	22	1000	nA
		V _{DS} = 0 V; V _{GS} = 10 V; T _j = 175 °C	-	-	10	μΑ
		V _{DS} = 0 V; V _{GS} = -10 V; T _j = 175 °C	-	-	10	μΑ
R _{DSon} drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 50 \text{ A}; T_j = 25 \text{ °C};$ see Figure 7; see Figure 8	-	8	9	mΩ	
		$V_{GS} = 10 \text{ V}$; $I_D = 50 \text{ A}$; $T_j = 175 \text{ °C}$; see Figure 7; see Figure 8	-	-	19	mΩ
I _D /I _{sense}	ratio of drain current to sense current	$V_{GS} > 10 \text{ V; } T_j > -55 \text{ °C; } T_j < 175 \text{ °C}$	450	500	550	
Dynamic	characteristics					
Q _{G(tot)}	total gate charge	$I_D = 25 \text{ A}; V_{DS} = 60 \text{ V}; V_{GS} = 10 \text{ V};$	-	121	-	nC
Q _{GS}	gate-source charge	T _j = 25 °C; see <u>Figure 14</u>	-	20	-	nC
Q_{GD}	gate-drain charge		-	44	-	nC
C _{iss}	input capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 25 \text{ V}; f = 1 \text{ MHz};$	-	4700	-	pF
C _{oss}	output capacitance	T _j = 25 °C; see <u>Figure 12</u>	-	800	-	pF
C _{rss}	reverse transfer capacitance		-	455	-	pF
t _{d(on)}	turn-on delay time	$V_{DS} = 30 \text{ V}; R_L = 1.2 \Omega; V_{GS} = 10 \text{ V};$	-	35	-	ns
t _r	rise time	$R_{G(ext)} = 10 \Omega$; $T_j = 25 °C$	-	108	-	ns
t _{d(off)}	turn-off delay time		-	185	-	ns
t _f	fall time		-	100	-	ns
L _D	internal drain inductance	measured from upper edge of drain mounting base to centre of die; $T_j = 25$ °C	-	2.5	-	nΗ
L _S	internal source inductance	measured from source lead to source bond pad; $T_j = 25 ^{\circ}\text{C}$	-	7.5	-	nΗ

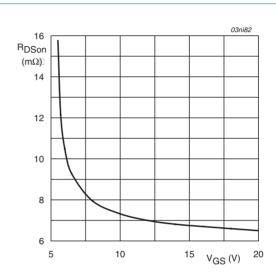
Table 6. Characteristics ... continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Source-dr	ain diode					
V_{SD}	source-drain voltage	$I_S = 25 \text{ A}; V_{GS} = 0 \text{ V}; T_j = 25 ^{\circ}\text{C};$ see <u>Figure 16</u>	-	0.85	1.2	V
t _{rr}	reverse recovery time	$I_S = 20 \text{ A}$; $dI_S/dt = -100 \text{ A/}\mu\text{s}$; $V_{GS} = -10 \text{ V}$;	-	75	-	ns
Qr	recovered charge	$V_{DS} = 30 \text{ V; } T_j = 25 \text{ °C}$	-	270	-	nC



 $T_j = 25^{\circ}C; t_p = 300 \mu s$

Fig 5. Output characteristics: drain current as a function of drain-source voltage; typical values



$$T_j = 25^{\circ}C; I_D = 50A$$

Fig 6. Drain-source on-state resistance as a function of gate-source voltage; typical values

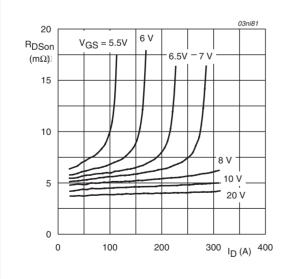
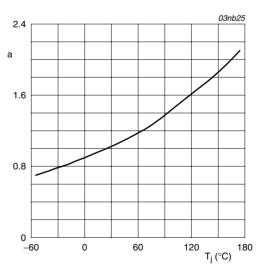


Fig 7. Drain-source on-state resistance as a function of drain current; typical values

 $T_i = 25^{\circ}C; t_p = 300 \mu s$



 $a = \frac{R_{DSon}}{R_{DSon(2.5^{\circ}C)}}$

Fig 8. Normalized drain-source on-state resistance factor as a function of junction temperature

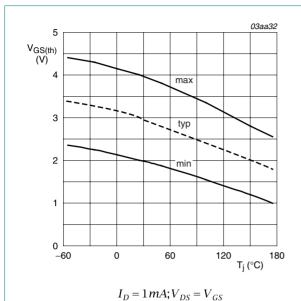
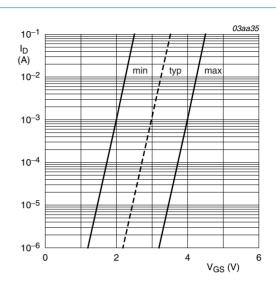
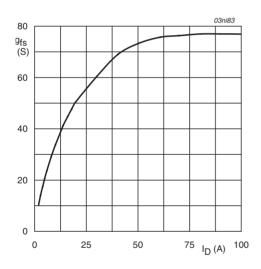


Fig 9. Gate-source threshold voltage as a function of junction temperature

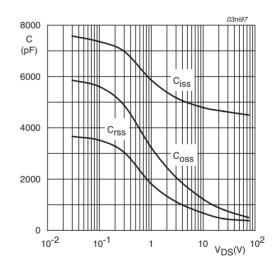


 $T_j=25\,^{\circ}C; V_{DS}=5V$

Fig 10. Sub-threshold drain current as a function of gate-source voltage



 $T_{j}=25\,^{\circ}C; V_{DS}=25V$ Fig 11. Forward transconductance as a function of drain current; typical values



 $V_{GS} = 0V; f = 1MHz$

Fig 12. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

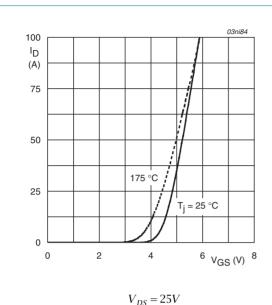


Fig 13. Transfer characteristics: drain current as a function of gate-source voltage; typical values

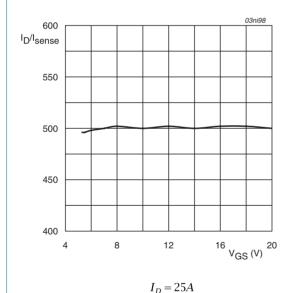
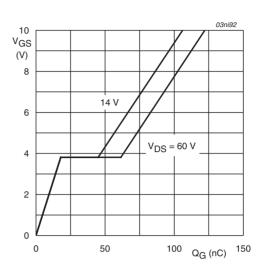


Fig 15. Drain-sense current ratio as a function of gate-source voltage; typical values



 $T_i = 25^{\circ}C; I_D = 25A$

Fig 14. Gate-source voltage as a function of turn-on gate charge; typical values

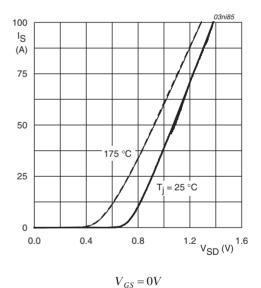
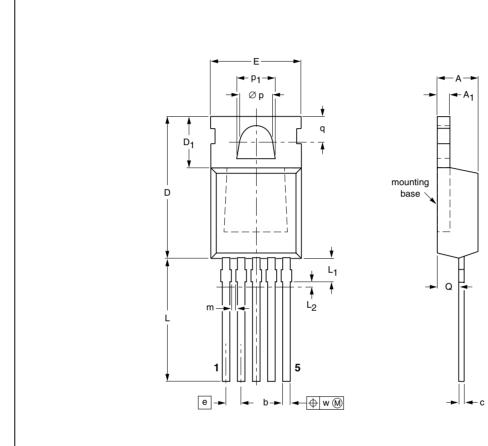


Fig 16. Reverse diode current as a function of reverse diode voltage; typical values

7. Package outline

Plastic single-ended package; heatsink mounted; 1 mounting hole; 5-lead TO-220

SOT263B



0 5 10 mm

DIMENSIONS (mm are the original dimensions)

UN	ТА	A ₁	b	С	D	D ₁	E	е	L	L ₁ ⁽¹⁾	L ₂ ⁽²⁾	m	Øp	P ₁	q	Q	w
mn	1 4.5 4.1	1.39 1.27	0.85 0.70	0.7 0.4	15.8 15.2	6.4 5.9	10.3 9.7	1.7	15.0 13.5	2.4 1.6	0.5	0.8 0.6	3.8 3.6	4.3 4.1	3.0 2.7	2.6 2.2	0.4

Notes

- 1. Terminal dimensions are uncontrolled in this zone.
- 2. Positional accuracy of the terminals is controlled in this zone.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT263B		5-lead TO-220	_		01-01-11

Fig 17. Package outline SOT263B (TO-220)

N-channel TrenchPLUS standard level FET

8. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
BUK7909-75AIE_2	20090217	Product data sheet	-	BUK71_7909_75AIE-01			
Modifications:	guidelines • Legal texts	of NXP Semiconductors. have been adapted to the	s been redesigned to comply with the new identity ors. to the new company name where appropriate. eparated from data sheet BUK71_7909_75AIE-01.				
BUK71_7909_75AIE-01 (9397 750 09879)	20020809	Product data sheet	-	-			

9. Legal information

9.1 Data sheet status

Document status [1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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